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Page 1

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

CIRKEL et al.

Examiner:

Vclez, R.

Serial No.:

10/527,569

Group Art Unit:

2829

Filed:

March 10, 2005

Docket No.:

NL020843 US

Title:

REDUCED CHIP TESTING SCHEME AT WAFER LEVEL

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence and the papers, as described hereinahove, are being transmitted via facsimile-formal Entry, to the attention of the Examiner at Commissioner for Patents, MAIL STOP AMENDMENT, P.O. Box 1450, Alexandria, VA 22313-1450,

on November 16, 2006.

Facsimile No.: 571 273-8300

Kelly & Legin

OFFICE ACTION RESPONSE AND AMENDMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Customer No. 24738

Dear Sir:

In response to the non-final Office Action dated August 21, 2006, please consider the following amendments and remarks.

A complete listing of the claims, to include any amendments presented therein, begins on page 2 of this paper.

Remarks/Arguments follow on page 4.

Authorization is provided to charge/credit Deposit Account 50-0996 (VLSI.503PA) any requisite fees/overages to enter this paper.